# **TR-56D**

## **Transceiver Module**

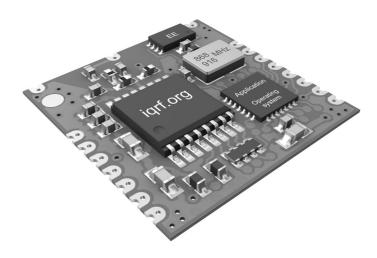
## **Data Sheet**





## **Description**

TR-56D is a family of IQRF transceiver modules operating in the 868 MHz and 916 MHz license free ISM (Industry, Scientific and Medical) frequency band. Its highly integrated ready-to-use design requires no external components. Extra low power consumption fits for battery powered applications. SMT mounting and very small dimensions allow space saving.



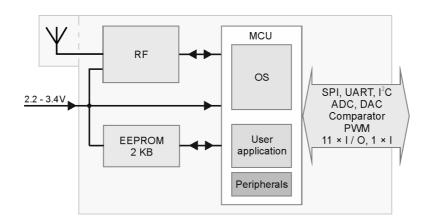
## **Key features**

- · Complete solution with operating system, easy to use
- FSK modulation
- Selectable RF band 868/916 MHz, multiple channel
- MCU with extended resources, user interrupt capability
- Extra low power consumption, power management modes
- · SPI interface supported by OS on background
- Serial EEPROM
- PWM output
- Programmable HW timer
- Battery monitoring
- 18 pins, 11 I/Os, 1 input only
- A/D converter (4 channels), D/A converter
- Analog comparator
- · Optional on-board antenna
- Stamp hole pads, SMT mounting, no SIM card compatible
- Very small dimensions

## **Applications**

- Telemetry
- · Building automation
- Control & regulation
- · Remote data acquisition
- · Communication links
- · Wireless networks
- RF connectivity in many other areas

## **Block diagram**





Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications.

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## Electrical specifications

Typical values unless otherwise stated

Parameters specified in this datasheet are typical values. They are at power supply  $V_{cc} = 3 \text{ V}$  only.  $V_{cc}$  voltage different from 3 V can impact on RF range and other parameters.

Supply voltage (V<sub>cc</sub>) <sup>1</sup> 3.0 V min., 3.4 V max., stabilized.

Operating temperature <sup>2</sup> -40 °C to +85 °C

Supply current

Sleep mode 380 nA (if all peripherals including MRF49XA disabled 4)

Run mode 1 mA (MRF49XA disabled)

Rx mode STD mode: 13 mA

LP mode  $^5$ : OS v3.01D: 400  $\mu$ A, from OS v3.02D: 330  $\mu$ A XLP mode  $^5$ : OS v3.01D: 35  $\mu$ A, from OS v3.02D: 25  $\mu$ A

Tx mode 14 mA – 24 mA (according to RF output power)
RF band 868 MHz or 916 MHz (software selectable)

Channels See IQRF OS User's guide, Appendix 2, Channel maps

RF data modulation FSK (frequency-shift keying)

RF data transmission bit rate 1.2 kb/s <sup>6</sup>, 19.2 kb/s, 57.6 kb/s <sup>6</sup>, 86.2 kb/s <sup>6</sup>

RFIC RF sensitivity See MRF49XA datasheet

RFIC RF output power Programmable in 8 levels (0 – 7), -2.5 dBm/level, see MRF49XA datasheet

RF range (TR-56DA) 3 Up to 300 m @ 19.2 kb/s 6

Input voltage on Q4 to Q15 pins 0 V to V<sub>cc</sub>

A/D converter

10 bit, 4 inputs, see PIC16LF1938 datasheet

15.2 mm x 14.9 mm x 2.0 mm (TR-56D)

23.3 mm x 14.9 mm x 2.0 mm (TR-56DA)

15.2 mm x 14.9 mm x 2.5 mm (TR-56DF)

23.3 mm x 14.9 mm x 2.5 mm (TR-56DF)

- **Note 1:** RF power and other parameters depend on supply voltage. Refer to datasheets of MCU and RF IC used. Test your application with respect to required supply voltage range.
- **Note 2:** RF range may change with lower temperature. Frost, condensation or humidity over 85% may disable module functionality. Module suitability should be tested in final application before volume use.
- **Note 3:** RF range strongly depends on module orientation and surroundings.
- Note 4: Additional current is consumed when a peripheral (e.g. watchdog, Brown-out detection etc.) is enabled.
- Note 5: Depends on interferences.
- Note 6: Bit rates different from 19.2 kb/s are preliminary, for experimental purpose only.

Users have to ensure observing local provisions and restrictions relating to the use of short range devices by software, e.g. the CEPT ERC/REC 70-03 Recommendation and subsequent amendments in EU.

TR-56DxF (with metallic shielding of RF circuitry) must be used in countries where FCC provision is valid.

Caution: Electrostatic sensitive device. Observe appropriate precautions for handling



## Absolute maximum ratings

Stresses above listed maximum values may cause permanent damage to the device and affect device reliability. Functional operation at these or any other conditions beyond those specified is not supported.

Supply voltage (V<sub>CC</sub>)

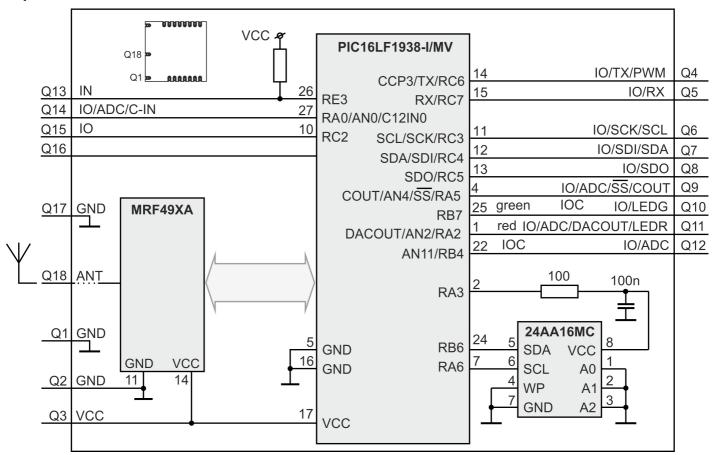
Voltage on Q4 to Q15 pins

Storage temperature Ambient temperature under bias

-0.3 V to (  $V_{\rm CC}$  + 0.3 V) -40 °C to +85 °C

-40 °C to +85 °C

## Simplified schematic



## **Basic components**

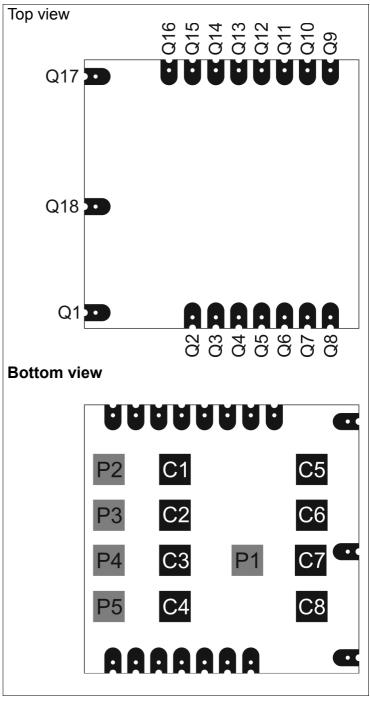
Part	Type	Manufacturer	Note
MCU	MCU PIC16LF1938–I/MV Microchip		
RF IC	MRF49XA Microchip		
EEPROM	24AA16/MC	Microchip	2 kB

For more information refer to respective datasheets.

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Pin Name		Description	
Q1 <sup>7</sup> (	GND	Ground	
Q2, C4 (	GND	Ground	То
Q3, C3 <b>VCC</b>		Power supply voltage	
Q4	IO/TX/PWM RC6 TX CCP3	General I/O pin UART TX PWM output	
Q5	IO/RX RC7 RX	General I/O pin UART RX	
Q6, C6	IO/SCK/SCL RC3 SCK SCL	General I/O pin SPI clock input I <sup>2</sup> C clock	
Q7, C7	IO/SDI/SDA RC4 SDI SDA	General I/O pin SPI data I <sup>2</sup> C data	
Q8 <sup>8</sup> , C8	IO/SDO RC5 SDO	General I/O pin SPI data out	
Q9, C5	IO/ADC/-SS/	_	
	RA5 AN4 –SS C2OUT	General I/O pin, RFPGM termination <sup>9</sup> Analog A/D input SPI Slave select Comparator output	В
Q10	IO/ LEDG RB7 LED1	General I/O pin, programmable pull-up and interrupt/wake-up on change (IOC) LEDR supported by OS	
Q11	IO/ADC/LEDF RA2 AN2 LED2 DACOUT	General I/O pin Analog A/D input LEDR supported by OS D/A converter output	
Q12	IO/ADC RB4 AN11	General I/O pin, programmable pull-up and interrupt/wake-up on change (IOC), RFPGM termination Analog A/D input	
Q13	IN RE3	General input only pin	
Q14, C1	IO/ADC/C-IN RA0 AN0 C12IN0	General I/O pin Analog A/D input Comparator –input	
Q15, C2	IO RC2	General I/O pin	
Q16	_	Do not use, leave unconnected	
Q17 <sup>7</sup>	GND	Ground	
Q18 <sup>8</sup>	ANT	Antenna	



Note 7: Not implemented for TR-56DAx.

For manufacturer only

P1-P5

**Note 8:** This pin is used as output during initial ~250 ms boot-up to recognize programming mode.

Note 9: External pull-up resistor must be used on this pin when used for RFPGM termination.

There are no on-board protection series resistors on I/O pins. It is recommended to use 200  $\Omega$  series resistors on each pin.

Figure 1: Relative RF range vs. level for the setTXpower (level) function. Refer to IQRF OS Reference guide.

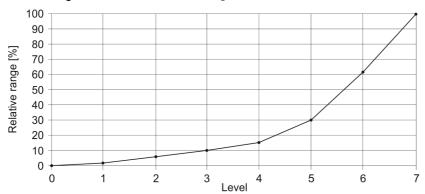


Figure 2: Relative RF range vs. level for the checkRF (level) function. Refer to IQRF OS Reference guide.

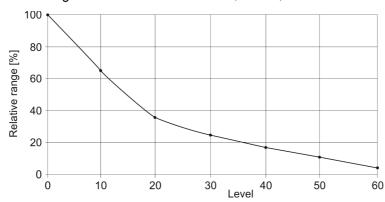
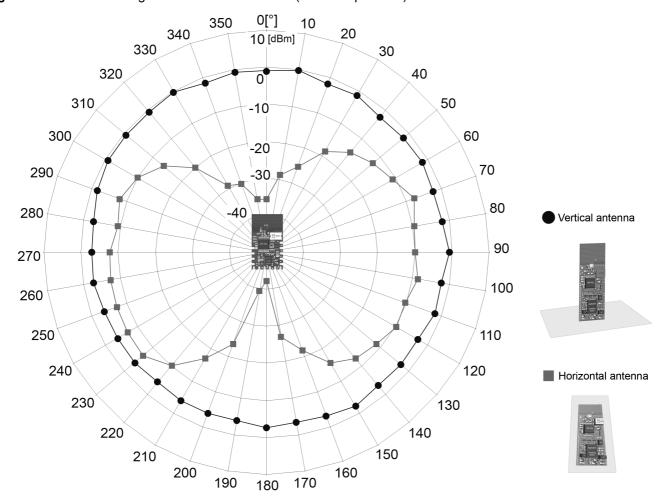


Figure 3: Relative RF range vs. antenna orientation (radiation patterns)





## Relative decrease of RF input signal vs. antenna edge spacing to conductive areas

Conductive areas close to the antenna must be avoided.

Figure 4: Perpendicular arrangement

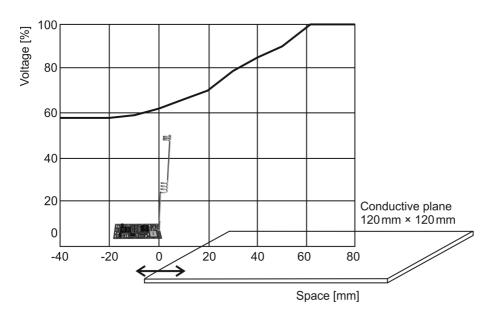
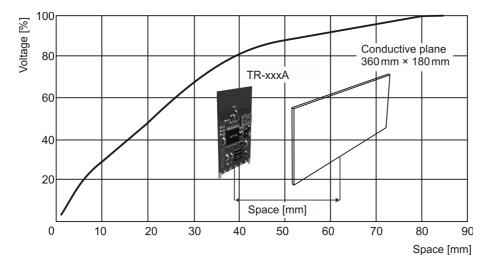


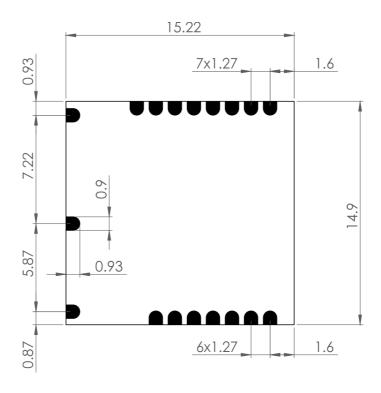
Figure 5: Parallel arrangement



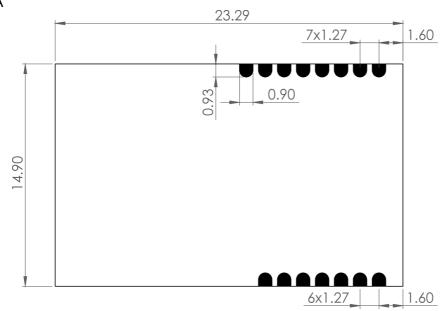


## **Mechanical drawings**

TR-56D



TR-56DA



Top view. Units: mm.



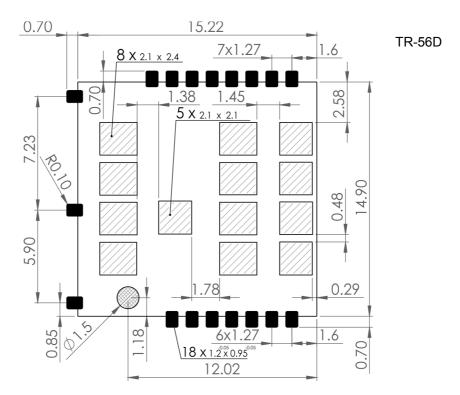
## **Application**

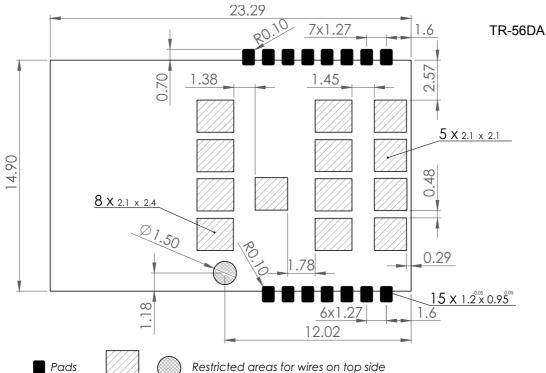
### **Assembly**

For proper mounting of surface mount TR-56Dx modules and avoiding damage during solder reflow assembly the IPC/JEDEC J-STD-020C standard must be observed. The parts must be baked dry according to IPC/JEDEC J-STD-033C, MSL 4 before reflow soldering. For reflow profile and details refer to the AN010 Application note – SMT mounting of IQRF TR modules.

### **Caution:** TR-56Dx must not be plugged in a SIM connector with metallic holder.

#### Recommended PCB layout:





Top view. Units: mm.



#### Operating system

See IQRF OS User's guide and IQRF OS Reference guide.

#### Software

See Application examples on www.iqrf.org website.

#### **Programming**

There are the following possibilities to upload an application program in TR-56Dx modules:

- Wired upload with TR-56Dx plugged via the SIM connector in the CK-USB-04A programmer.
- For TR-56Dx modules populated in an application:
  - Wired upload using the CK-USB-04A programmer. See the CK-USB-04A User's guide.
  - Wired upload using the CK-USB-04 programmer and the KON-TR-01P adapter. See the KON-TR-01P User's guide.
  - RFPGM RF programming™ (wireless upload). See the IQRF OS User's guide, Appendix RF programming.

#### Solderless development prototyping

For flexible development of TR-54D and TR-56D applications the TRDB-54DA kit is intended. It is a removable SIM-compatible device containing the TR-54DA (fully compatible with TR-56DA) which can be plugged in the SIM connector in user equipment or in an appropriate IQRF development kit, e.g. DK-EVAL-04. Refer to the TR-DB-54DA User's guide for details.

In countries where FCC provision is valid, the requirements stated in CB-400-Modular Approval Checklist\_JS\_WIP.pdf have to be observed. Refer to <a href="https://www.iqrf.org/download">www.iqrf.org/download</a>, "FCC checklist".

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can *radiate* radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult IQRF support or an experienced local distributor technician for help.



### **Product information**

## **Ordering codes**

TR-56DAPP

peripheral options: nil - No shielding

- RF shielding

nil - Soldering padhole (no antenna, no U.FL connector) antenna options:

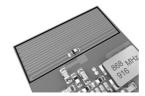
- PCB antenna.

- U.FL connector (mini coax)

Type Antenna option		RF shielding
TR-56D	Soldering pad-hole	-
TR-56DA Internal PCB antenna		_
TR-56DF Soldering pad-hole		Yes
TR-56DAF Internal PCB antenna		Yes







TR-56DA



TR-56DF

## **Document history**

•	141219	Information regarding FCC directives updated.
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141103 Chapters Pin description and Programming slightly updated.

Information regarding directives FCC, RoHS and WEEE updated and extended.

Supply voltage and RF range revised. 140430

Datasheet file renamed from DS TR-56D 131217 to Datasheet TR-56D 140120. 140120

Recommended PCB design slightly changed. 131217

Certification updated for the latest directives. 131114

Pin description extended, bottom view added. TR-56DA mechanical drawing added. F-option with RF 130906

shielding available. Recommended PCB layout added. Electrical specification simplified.

Chapter Solderless development prototyping updated. 130703

Operational temperature range extended. 130607

Preliminary, for HW v1.00. 130405

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Complies with FCC directives Part 15 Low Power Communication Device Transmitter. FCC ID: R24TR-5XDX.

Complies with directives 2011/65/EU (RoHS) and 2012/19/EU (WEEE).

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